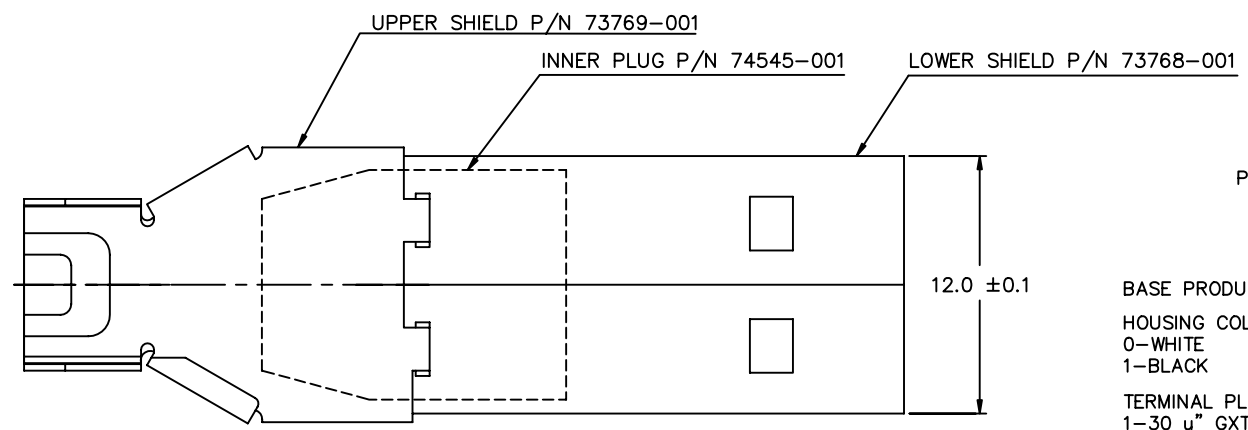
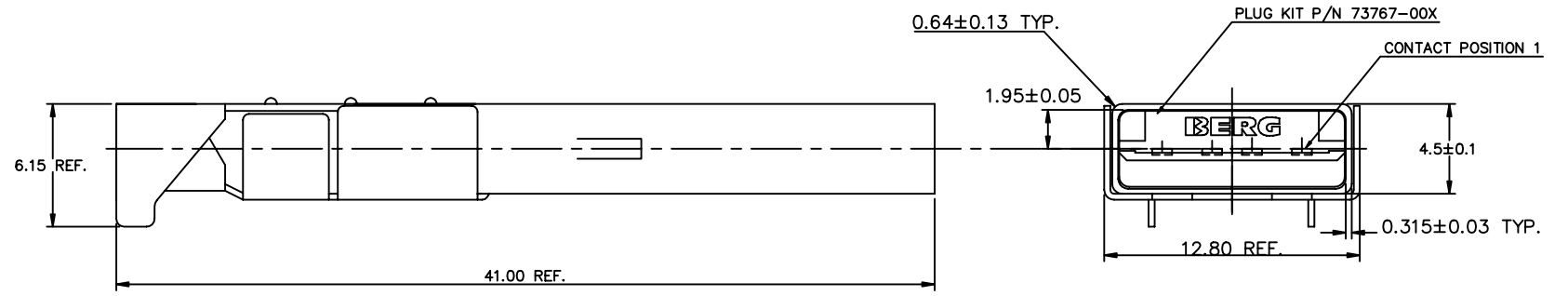


Tous droits strictement réservés. Reproduction ou communication à des tiers interdite sans autorisation écrite du propriétaire.  
 Property of c. BERG ELECTRONICS.  
 Copyright BERG ELECTRONICS by



All rights strictly reserved. Reproduction or issue to third parties in any form without written authority from the proprietor.  
 Property of c. BERG ELECTRONICS.  
 Copyright BERG ELECTRONICS by

PRODUCT NO.  
74033



PRODUCT NUMBER CODE  
7 4 0 3 3 - X 0 X LF

BASE PRODUCT NUMBER  
HOUSING COLOR OPTION  
0-WHITE  
1-BLACK

TERMINAL PLATING OPTION  
1-30 u" GXT IN CONTACT AREA  
100u" TIN/LEAD IN SOLDER AREA  
3-30 u" Au IN CONTACT AREA  
100u" TIN/LEAD IN SOLDER AREA

LEAD FREE OPTION  
IF LEAD FREE OPTION SELECTED, THE TIN/LEAD PLATING WERE REPLACED BY PURE TIN

- NOTES:
- MATERIAL:  
SHIELD: SPCC  
CONTACTS : COPPER ALLOY  
HOUSING : UL 94V-0 THERMOPLASTIC COLOR: SEE PRODUCT NUMBER CODE
  - CONTACT PLATING : SEE PRODUCT NUMBER CODE
  - SHIELD PLATING : 2.5 um MINIMUM NICKEL.
  - PRINT IS ONLY FOR ASSEMBLY REFERENCE
  - PACKING STANDARD GS-14-920 WILL BE APPLIED FOR LEAD FREE P/N'S
  - FOR LEAD FREE P/N, THE PRODUCT MEET EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008
  - FOR LEAD FREE P/N'S, THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 40 SECONDS IN A HAND SOLDERING OR WAVE SOLDERING PROCESS.

mat'l code		tolerance unless otherwise specified		CUSTOMER COPY	FCJ www.fciconnect.com	
rev.	ecn no.	dr	date	linear	.0 ± 0.3	projection 
A	T70418	P P	10/06/97		.00 ± 0.20	
B	T80026	P P	01/20/98		.000 ± 0.10	
C	T80068	P P	02/16/98	angles	± 2°	unit mm scale 4 : 1 A3
D	T80388	P P	08/27/98	dr	PETER 08/14/97	
E	T80579	P P	12/21/98	engr	R Y LIU 08/14/97	
F	N05-0247	P H	08/30/05	chr	R Y LIU 08/14/97	
G	N08-0162	R.B	2008/08/08	appd	JENN TSAO 08/14/97	
sheet	revisor	G				
index	sheet	1				